

## General Description

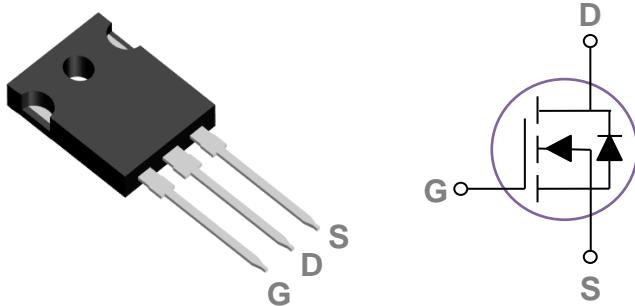
These N-Channel enhancement mode power field effect transistors are planar stripe, DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supply

BVDSS	RDS(ON)	ID
100V	2.6mΩ	240A

## Features

- 100V, 240A, RDS(ON) = 2.6mΩ@VGS = 10V
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

## TO247 Pin Configuration



## Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	100	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current – Continuous ( $T_c=25^\circ\text{C}$ )	240	A
	Drain Current – Continuous ( $T_c=100^\circ\text{C}$ )	152	A
$I_{DM}$	Drain Current – Pulsed <sup>1</sup>	960	A
EAS	Single Pulse Avalanche Energy <sup>2</sup>	910	mJ
IAS	Single Pulse Avalanche Current <sup>2</sup>	135	A
$P_D$	Power Dissipation ( $T_c=25^\circ\text{C}$ )	380	W
	Power Dissipation – Derate above 25°C	3.04	W/°C
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
$T_J$	Operating Junction Temperature Range	-55 to 150	°C

## Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	62	°C/W
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	0.33	°C/W



100V N-Channel MOSFETs

PDX00D8BH

**Electrical Characteristics ( $T_J=25\text{ }^{\circ}\text{C}$ , unless otherwise noted)****Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$ , $I_D=250\mu\text{A}$	100	---	---	V
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=80\text{V}$ , $V_{GS}=0\text{V}$ , $T_J=25\text{ }^{\circ}\text{C}$	---	---	1	uA
		$V_{DS}=80\text{V}$ , $V_{GS}=0\text{V}$ , $T_J=85\text{ }^{\circ}\text{C}$	---	---	10	uA
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 20\text{V}$ , $V_{DS}=0\text{V}$	---	---	$\pm 100$	nA

**On Characteristics**

$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}$ , $I_D=20\text{A}$	---	2.2	2.6	mΩ
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D = 250\mu\text{A}$	2	2.5	4	V
$g_{fs}$	Forward Transconductance	$V_{DS}=10\text{V}$ , $I_D=3\text{A}$	---	21	---	S

**Dynamic and switching Characteristics**

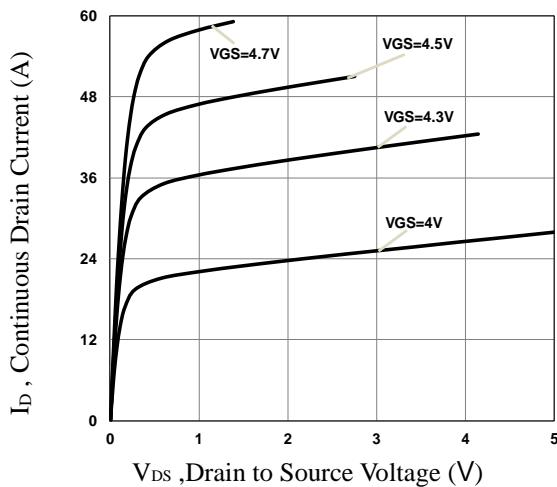
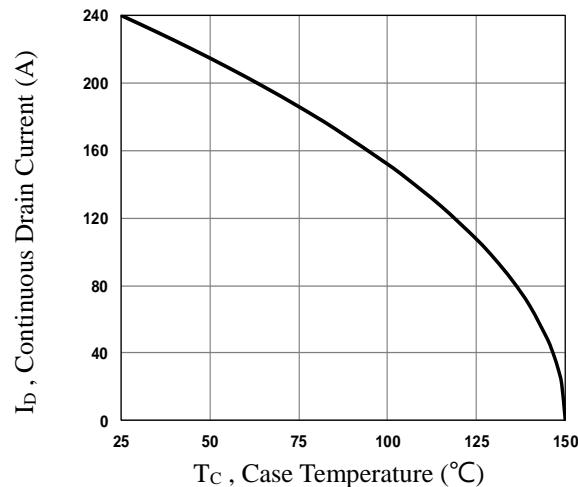
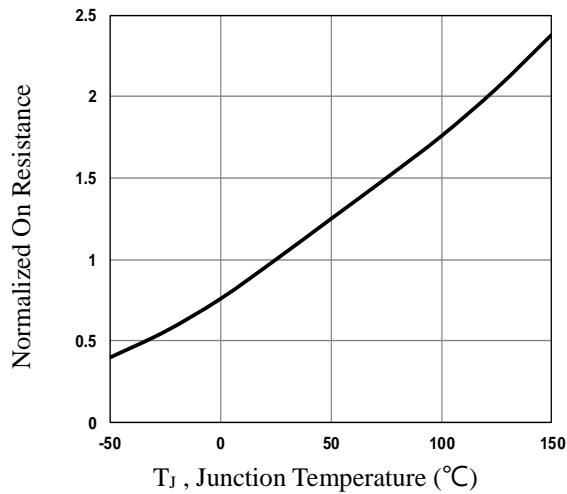
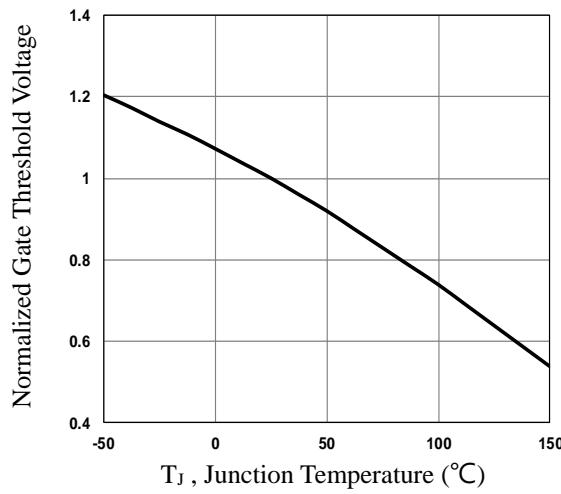
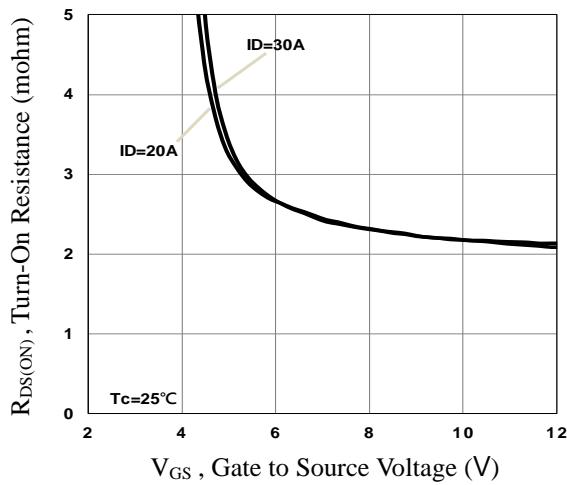
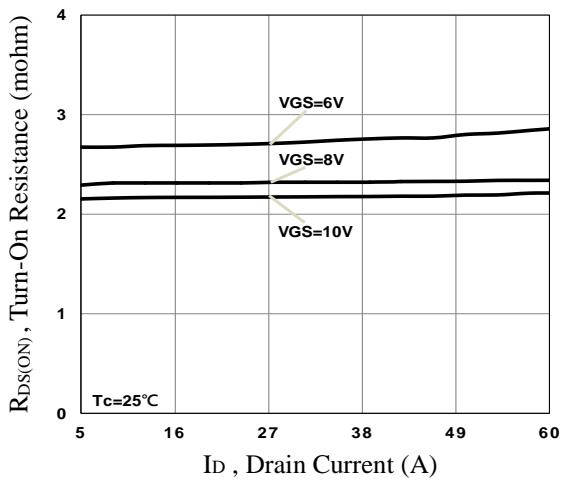
$Q_g$	Total Gate Charge <sup>3,4</sup>	$V_{DS}=50\text{V}$ , $V_{GS}=10\text{V}$ , $I_D=100\text{A}$	---	122	185	nC
$Q_{gs}$	Gate-Source Charge <sup>3,4</sup>		---	27	40	
$Q_{gd}$	Gate-Drain Charge <sup>3,4</sup>		---	33	50	
$T_{d(on)}$	Turn-On Delay Time <sup>3,4</sup>	$V_{DD}=50\text{V}$ , $V_{GS}=10\text{V}$ , $R_G=6\Omega$ $I_D=100\text{A}$	---	20	30	ns
$T_r$	Rise Time <sup>3,4</sup>		---	32	50	
$T_{d(off)}$	Turn-Off Delay Time <sup>3,4</sup>		---	98	150	
$T_f$	Fall Time <sup>3,4</sup>		---	32	50	
$C_{iss}$	Input Capacitance	$V_{DS}=50\text{V}$ , $V_{GS}=0\text{V}$ , $F=1\text{MHz}$	---	7700	11550	pF
$C_{oss}$	Output Capacitance		---	1500	2250	
$C_{rss}$	Reverse Transfer Capacitance		---	30	45	
$R_g$	Gate resistance	$V_{GS}=0\text{V}$ , $V_{DS}=0\text{V}$ , $F=1\text{MHz}$	---	1	---	Ω

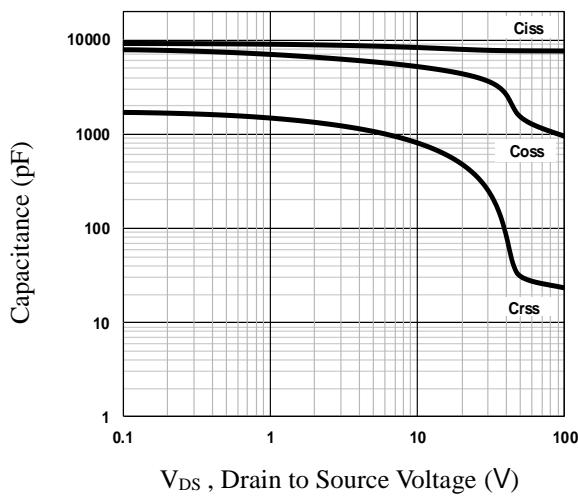
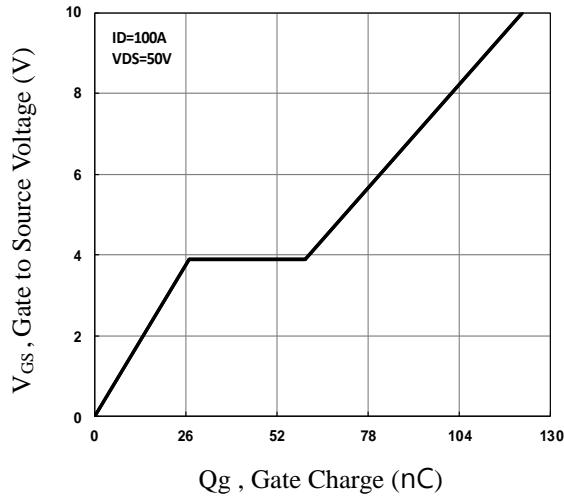
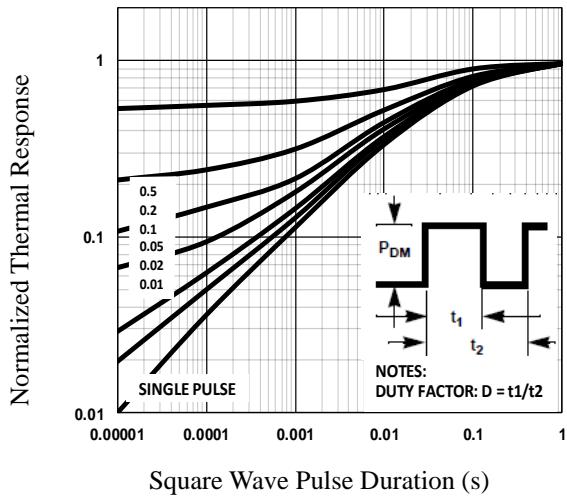
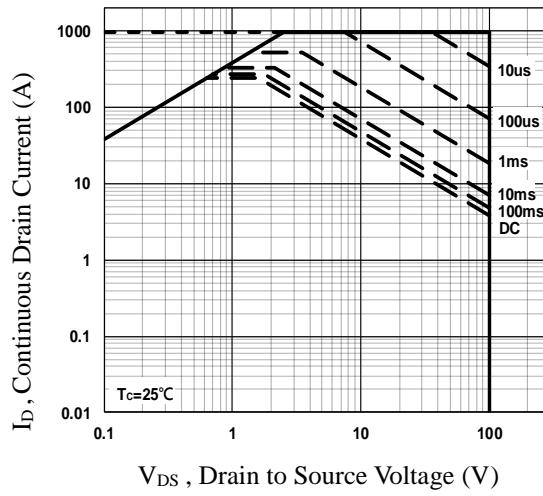
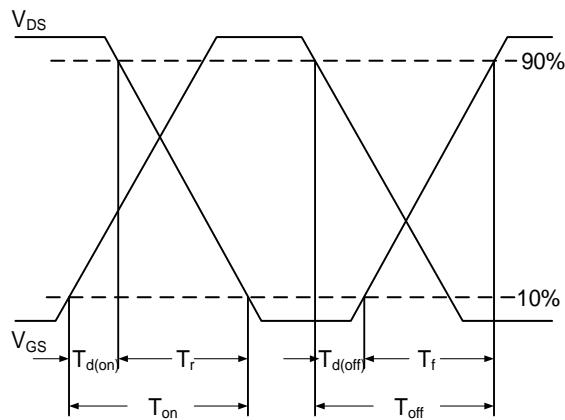
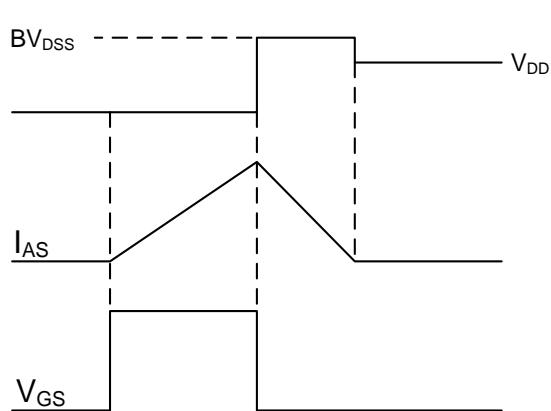
**Drain-Source Diode Characteristics and Maximum Ratings**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous Source Current	$V_G=V_D=0\text{V}$ , Force Current	---	---	240	A
$I_{SM}$	Pulsed Source Current		---	---	480	A
$V_{SD}$	Diode Forward Voltage	$V_{GS}=0\text{V}$ , $I_s=1\text{A}$ , $T_J=25\text{ }^{\circ}\text{C}$	---	---	1	V
$t_{rr}$	Reverse Recovery Time	$V_R=100\text{V}$ , $I_s=10\text{A}$ $di/dt=100\text{A}/\mu\text{s}$ , $T_J=25\text{ }^{\circ}\text{C}$	---	250	---	ns
$Q_{rr}$	Reverse Recovery Charge		---	820	---	uC

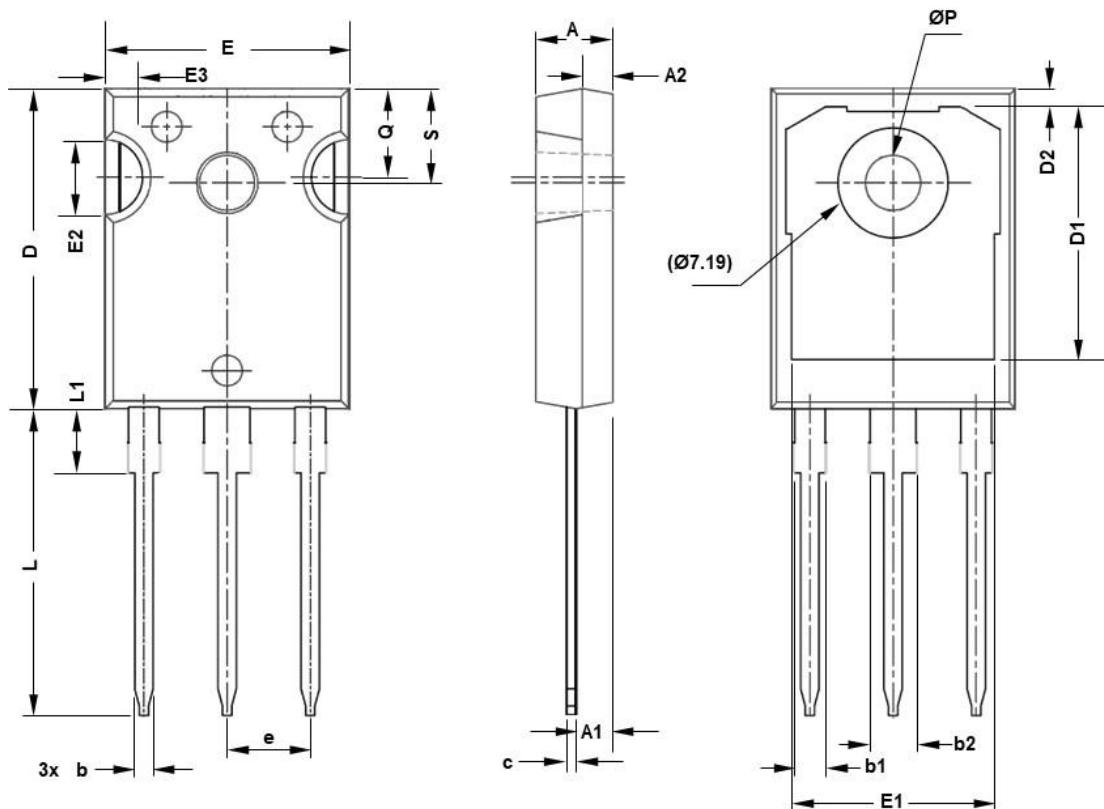
Note :

- Repetitive Rating : Pulsed width limited by maximum junction temperature.
- $V_{DD}=50\text{V}$ ,  $V_{GS}=10\text{V}$ ,  $L=0.1\text{mH}$ ,  $I_{AS}=135\text{A}$ ,  $R_G=25\Omega$ , Starting  $T_J=25\text{ }^{\circ}\text{C}$ .
- The data tested by pulsed , pulse width  $\leq 300\text{us}$  , duty cycle  $\leq 2\%$ .
- Essentially independent of operating temperature.


**Fig.1 Typical Output Characteristics**

**Fig.2 Continuous Drain Current vs.  $T_c$** 

**Fig.3 Normalized RDSON vs.  $T_j$** 

**Fig.4 Normalized  $V_{th}$  vs.  $T_j$** 

**Fig.5 Turn-On Resistance vs.  $V_{GS}$** 

**Fig.6 Turn-On Resistance vs.  $I_D$**


**Fig.7 Capacitance Characteristics**

**Fig.8 Gate Charge Characteristics**

**Fig.9 Normalized Transient Impedance**

**Fig.10 Maximum Safe Operation Area**

**Fig.11 Switching Time Waveform**

**Fig.12 EAS Waveform**

## TO247 PACKAGE INFORMATION



SYMBOL	mm		SYMBOL	mm	
	MIN	MAX		MIN	MAX
A	4.83	5.21	E2	4.32	5.49
A1	2.29	2.55	E3	2.15	2.80
A2	1.50	2.49	e	5.44BSC	
b	1.12	1.33	L	19.81	20.32
b1	1.91	2.39	L1	4.10	4.40
b2	2.87	3.22	φP	3.56	3.65
C	0.55	0.69	Q	5.39	6.20
D	20.80	21.10	S	6.04	6.30
D1	16.25	17.65			
D2	0.51	1.35			
E	15.75	16.13			
E1	13.46	14.16			